

封装

封装名	外形尺寸图	推荐焊盘尺寸图
<p>SOT-26B</p>	<p>Top View: Overall width 2.9 ± 0.2, lead spacing 1.9 ± 0.2, lead width 0.95, lead height $1.6^{+0.2}$. Pin positions 1, 2, 3, 4, 5, 6 are indicated.</p> <p>Side View: Lead thickness $0.125^{+0.10}_{-0.05}$, lead height $2.8^{+0.3}$, minimum lead height $\text{min. } 0.2$.</p> <p>Bottom View: Lead width 0.4 ± 0.1, lead pitch $\phi 0.120$, lead thickness $0.05^{+0.10}_{-0.05}$, lead height $1.15^{+0.28}_{-0.18}$, and a 0.10 chamfer.</p>	<p>Recommended pad layout showing a central pad width of 0.7 and a total pad width of 2.4. Pad spacing is 0.95 and pad height is 1.0.</p>
<p>SOT89-5A</p>	<p>Top View: Overall width 4.5 ± 0.1, lead spacing 0.42 ± 0.07, lead width 0.9, lead height 2.5 ± 0.1, and a $4.25^{+0.5}_{-0.3}$ dimension. Pin positions 1, 2, 3, 4, 5 are indicated.</p> <p>Side View: Lead thickness 1.5 ± 0.1, lead height 0.44 max..</p> <p>Bottom View: Lead width 0.42 ± 0.07, lead pitch 0.47 ± 0.07, and a $\phi 1.0$ diameter hole.</p> <p>(Bottom View): Lead width 1.6 ± 0.2, lead height 0.2, and a 0.4 dimension.</p>	<p>Recommended pad layout showing a central pad width of 1.00 and a total pad width of 2.00. Pad spacing is 1.50 and pad height is 0.70.</p>